

### 18-3508-311 Information

Heisener.com

Part Number 18-3508-311
Manufacturer Aries Electronics

**Category** Connectors, Interconnects

Sockets for ICs, Transistors

**Description** CONN IC DIP SOCKET 18POS GOLD

Package -

For the pricing/inventory/lead time, please contact

us

For Reference Only

Website: https://www.heisener.com
E-mail: salesdept@heisener.com



Request a Quote

# **Certified Quality**

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









## **18-3508-311 Specifications**

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Manufacturer Part Number	18-3508-311
Manufacturer	Aries Electronics
Category	Connectors, Interconnects
	Sockets for ICs, Transistors
Package	-
Series	508
Type	DIP, 0.3" (7.62mm) Row Spacing
Number of Positions or Pins (Grid)	18 (2 x 9)
Pitch - Mating	0.100" (2.54mm)
Contact Finish - Mating	Gold
Contact Finish Thickness - Mating	30μin (0.76μm)
Contact Material - Mating	Beryllium Copper
Mounting Type	Through Hole
Features	Open Frame
Termination	Wire Wrap
Pitch - Post	0.100" (2.54mm)
Contact Finish - Post	Gold
Contact Finish Thickness - Post	10μin (0.25μm)
Contact Material - Post	Brass
Housing Material	Polyamide (PA46), Nylon 4/6, Glass Filled
Operating Temperature	-55°C ~ 125°C
	Report errors?

#### 18-3508-311 Guarantees



#### **Quality Guarantees**

We provide 90 days warranty. \*

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



#### **Service Guarantees**

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

### **18-3508-311 Payment Methods**



















# 18-3508-311 Shipping Methods













If you have any question about 18-3508-311, please do not hesitate to contact us!

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